

PROCEEDINGS OF SPIE

***Laser Applications in
Microelectronic and
Optoelectronic Manufacturing
(LAMOM) XXVIII***

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Editors

**30 January – 1 February 2023
San Francisco, California, United States**

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Published by
SPIE

Volume 12408

Proceedings of SPIE 0277-786X, V. 12408

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Author(s), "Title of Paper," in *Laser Applications in Microelectronic and Optoelectronic Manufacturing (LAMOM) XXVIII*, edited by Aiko Narazaki, Laura Gemini, Jan Kleinert, Proc. of SPIE 12408, Seven-digit Article CID Number (DD/MM/YYYY); (DOI URL).

ISSN: 0277-786X
ISSN: 1996-756X (electronic)

ISBN: 9781510659216
ISBN: 9781510659223 (electronic)

Published by
SPIE
P.O. Box 10, Bellingham, Washington 98227-0010 USA
Telephone +1 360 676 3290 (Pacific Time)
SPIE.org
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